

Notice of References Cited	Application/Control No. 10/034,221	Applicant(s)/Patent Under Reexamination PYI, SEUNG HO	
	Examiner Matthew A. Anderson	Art Unit 1765	Page 1 of 1

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*	B	US-6491752 B1	12-2002	Kirscht et al.	117/21
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*	D	US-2002/0100917 A1	08-2002	Chu et al.	257/197
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*	F	US-5565690	10-1996	Theodore et al.	257/18
*	G	US-5561302	10-1996	Candelaria	257/24
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*	N	JP-2001237247A	08-2001	Japan	Iida et al.	H01L021/322
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NON-PATENT DOCUMENTS

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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.

Matthew A. Anderson 3/9/04